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प्लाज़मा अनुसंधान संस्थान INSTITUTE FOR PLASMA RESEARCH ाणु ऊर्जा विभाग, भारत सरकार का एक सहायता प्राप्त



परमाणु ऊर्जा विभाग, भारत सरकार का एक सहायता प्राप्त संस्थान

An Aided Institute of Department of Atomic Energy, Government of India

इन्दिरा पुल के पास, भाट, गांधीनगर - 382 428 भारत

दूरभाष: (079) 2396 2020/2021/2028 फेक्स: 91-079-23962277

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Fax : 91-079-23962277 Web : <u>www.ipr.res.in</u>

ENQUIRY

ENQUIRY NO : IPR/EQL/18-19/140

Date : 30-07-2018

Due on : 23-08-2018 by 1:00 PM IST

Please send your offer in sealed envelope specifying Enquiry No, Date & Due Date, ALONG WITH your credentials for the following items:

Important Note:

Please note that e-mail quotations are not acceptable however you may send your queries (if any) to localpurchase@ipr.res.in

Please ensure your sealed quotation reaches this office not later than above mentioned due date and time.

Kindly go through the following documents properly before quoting which are available on the IPR web portal i.e., http://www.ipr.res.in/documents/tender-terms.html / attached herewith.

- 1) Instructions to the bidders & Terms and conditions (refer Form No: IPR-LP-01.V4)
- 2) Bidding format

GST for Goods and Services (IGST/CGST/SGST TAX BENEFITS): Please refer clause no: 8 of Form No: IPR-LP-01.V4

QUOTATION SHOULD BE ADDRESSED TO PURCHASE OFFICER ONLY

Sr No	Description	Quantity
1	HSS DIE 5MM , Size : 5 mm x 0.8 mm Pitch, Preferred Make : Totem, Addison, Miranda or Its Equivalent. (IPR CODE:22 DI91 1004)	10.0 Nos.
2	HSS DIE 1 Inch BSP , Size : 1 Inch BSP, Preferred Make : Totem, Addison, Miranda or Its Equivalent. (IPR CODE:22 DI91 1106)	5.0 Nos.
3	HSS DIE 1/4 Inch UNF , Size : 1/4 Inch UNF, Preferred Make : Totem, Addison, Miranda or Its Equivalent. (IPR CODE:22 DI91 1151)	5.0 Nos.

Note: 1.Delivery within 15days from the date of PO.

Encl: As per attachment.

Sd/-

Information to Vendors: We are working towards a single platform for our future requirement. Hence, please refer IPR website i.e, http://www.ipr.res.in/documents/tenderseng.html for our future requirement.